



Parameter	Ratings	Units
Blocking Voltage	350	V _P
Load Current	120	mA
Max On-resistance	35	Ω

Features

- Small 6-Pin Package
- Low Drive Power Requirements (TTL/CMOS Compatible)
- Arc-Free With No Snubbing Circuits
- 3750V_{rms} Input/Output Isolation
- FCC Compatible
- VDE Compatible
- No EMI/RFI Generation
- Machine Insertable, Wave Solderable
- Surface Mount Tape & Reel Version Available

Applications

- Telecommunications
 - Telecom Switching
 - Tip/Ring Circuits
 - Modem Switching (Laptop, Notebook, Pocket Size)
 - Hook Switch
 - Dial Pulsing
 - Ground Start
 - Ringing Injection
- Instrumentation
 - Multiplexers
 - Data Acquisition
 - Electronic Switching
 - I/O Subsystems
 - Meters (Watt-Hour, Water, Gas)
- Medical Equipment-Patient/Equipment Isolation
- Security
- Aerospace
- Industrial Controls

Description

The LCB110 is a 1-Form-B (normally closed) relay which uses optically coupled MOSFET technology to provide 3750V_{rms} of input to output isolation. The efficient MOSFET switches and photovoltaic die use Clare's patented OptoMOS® architecture. A highly efficient GaAlAs infrared LED controls the optically coupled output. The LCB110 has low on-resistance and is well suited for most applications requiring a normally closed relay.

Approvals

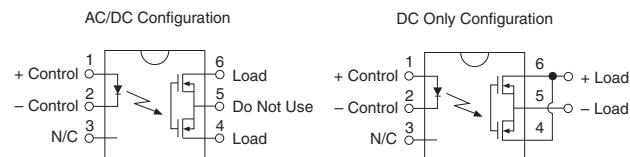
- UL Recognized Component: File # E76270
- CSA Certified Component: Certificate # 1175739
- EN/IEC 60950-1 Compliant

Ordering Information

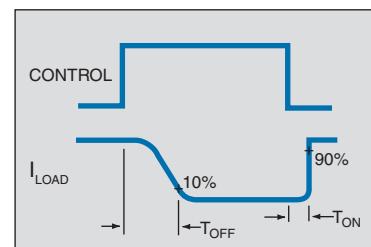
Part #	Description
LCB110	6-Pin DIP (50/Tube)
LCB110S	6-Pin Surface Mount (50/Tube)
LCB110STR	6-Pin Surface Mount (1000/Reel)

* For other packaging options consult factory.

Pin Configuration



Switching Characteristics of Normally Closed (Form B) Devices



Absolute Maximum Ratings

Parameter	Ratings	Units
Blocking Voltage	350	V _P
Reverse Input Voltage	5	V
Input Control Current Peak (10ms)	50	mA
	1	A
Input Power Dissipation ¹	150	mW
Total Power Dissipation ²	800	mW
Isolation voltage Input to Output	3750	V _{rms}
Operational Temperature	-40 to +85	°C
Storage Temperature	-40 to +125	°C

¹ Derate Linearly 3.33 mw / °C

² Derate Linearly 6.67 mw / °C

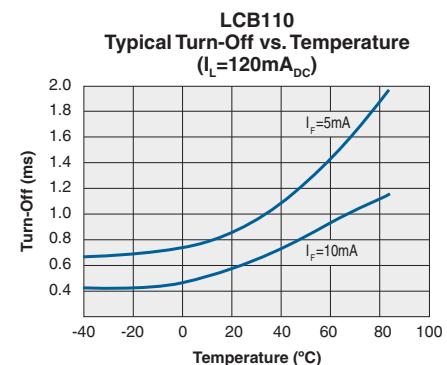
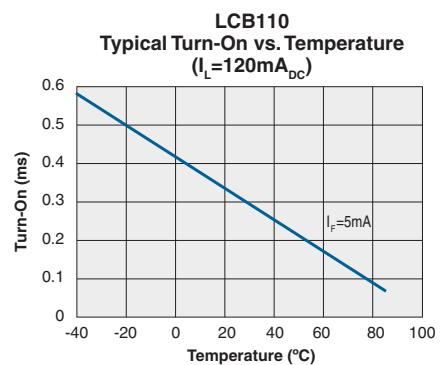
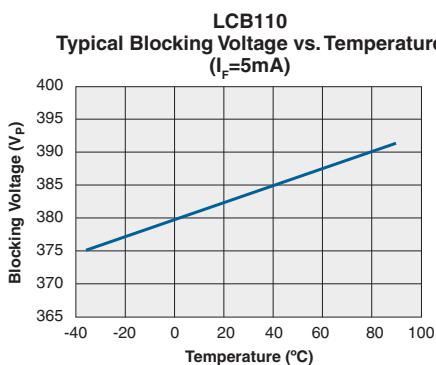
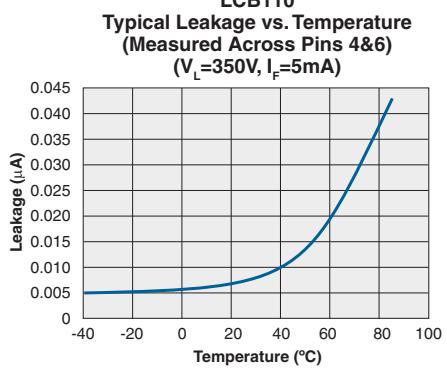
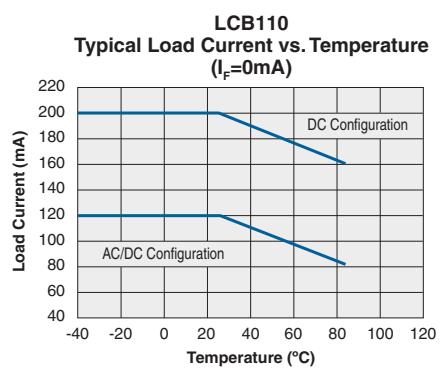
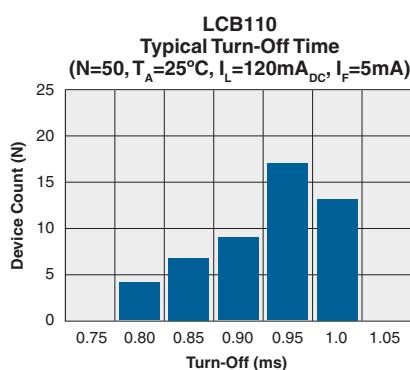
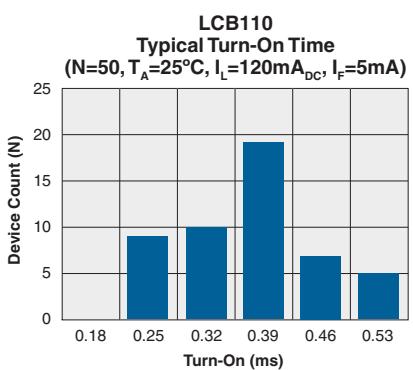
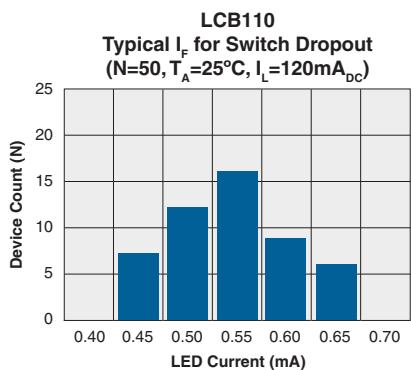
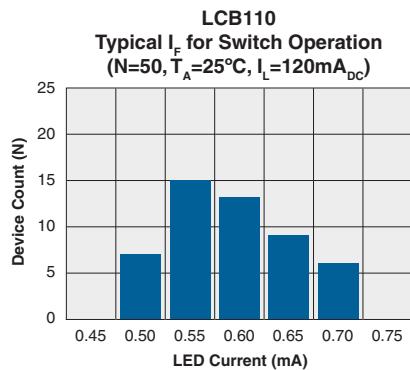
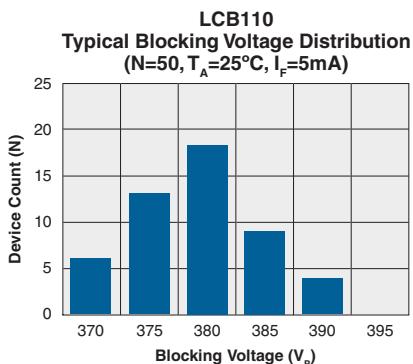
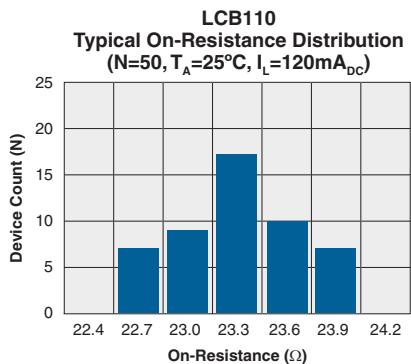
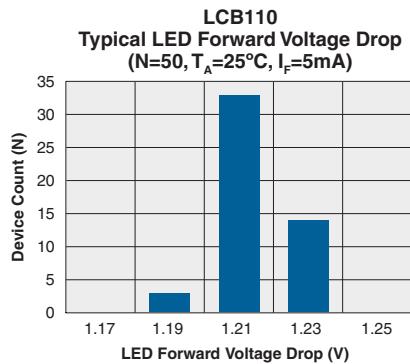
Electrical absolute maximum ratings are at 25°C

Absolute Maximum Ratings are stress ratings. Stresses in excess of these ratings can cause permanent damage to the device. Functional operation of the device at conditions beyond those indicated in the operational sections of this data sheet is not implied.

Electrical Characteristics

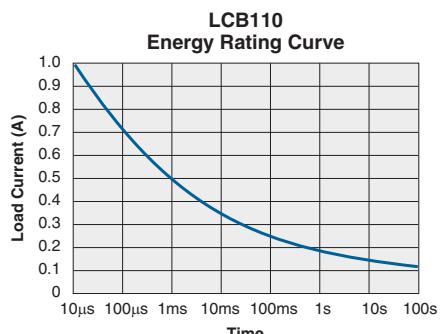
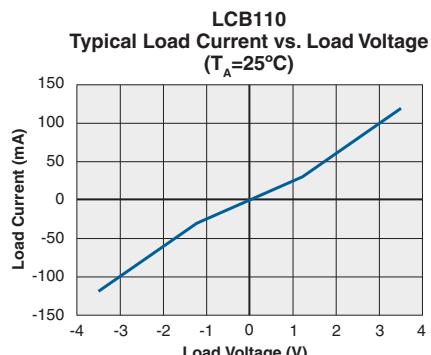
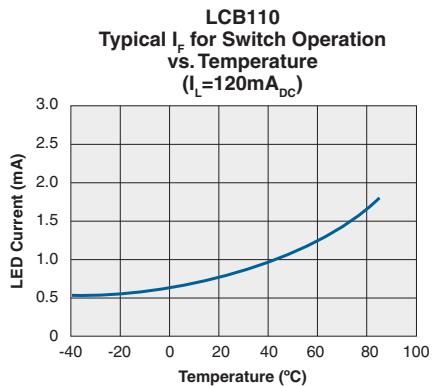
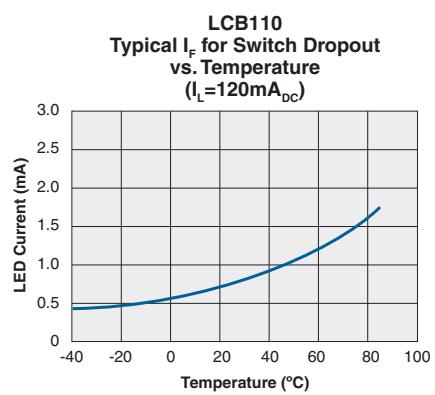
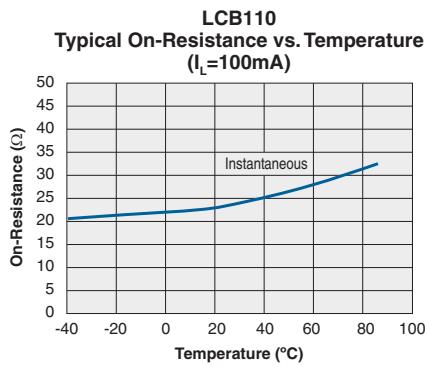
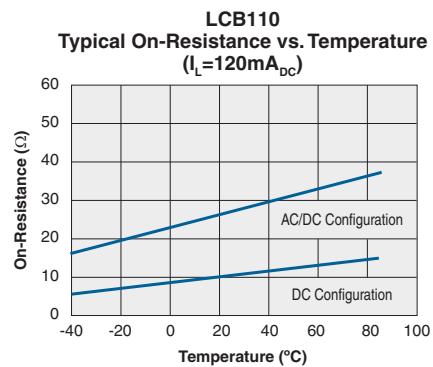
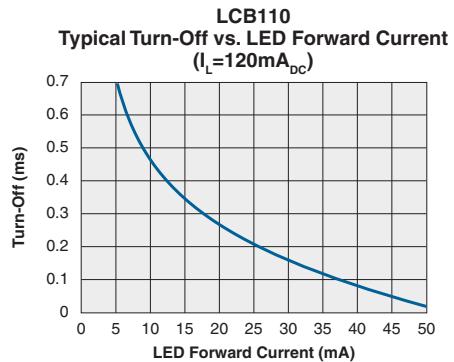
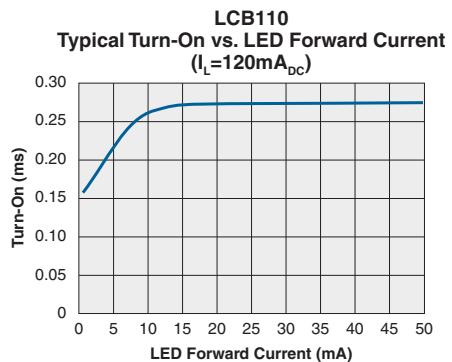
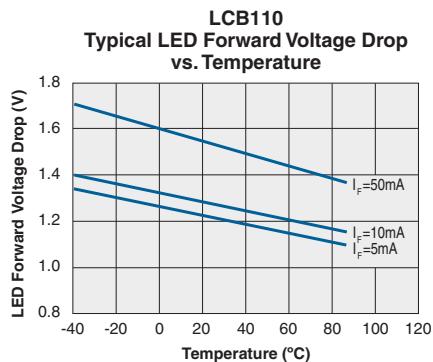
Parameter	Conditions	Symbol	Min	Typ	Max	Units
Output Characteristics @ 25°C						
Load Current Continuous AC/DC Configuration DC Configuration	-	I _L	-	-	120	mA
					200	
Peak Load Current	t=10ms	I _L	-	-	350	mA
On-Resistance AC/DC Configuration DC Configuration	I _L =120mA	R _{ON}	-	23	35	Ω
				7	10	
Off-State Leakage Current	I _F =5mA, V _L =350V _P	I _{LEAK}	-	-	1	μA
Switching Speeds Turn-On Turn-Off	I _F =5mA, V _L =10V	t _{ON}	-	0.38	3	ms
				0.93	3	
Output Capacitance	I _F =5mA, 50V, f=1MHz	C _{OUT}	-	25	-	pF
Input Characteristics @ 25°C						
Input Control Current	I _L =120mA	I _F	-	-	5	mA
Input Dropout Current	-	I _F	0.4	0.7	-	mA
Input Voltage Drop	I _F =5mA	V _F	0.9	1.2	1.4	V
Reverse Input Current	V _R =5V	I _R	-	-	10	μA
Common Characteristics @ 25°C						
Input to Output Capacitance	-	C _{IO}	-	3	-	pF

PERFORMANCE DATA*



*The Performance data shown in the graphs above is typical of device performance. For guaranteed parameters not indicated in the written specifications, please contact our application department.

PERFORMANCE DATA*



*The Performance data shown in the graphs above is typical of device performance. For guaranteed parameters not indicated in the written specifications, please contact our application department.

Manufacturing Information

Soldering

For proper assembly, the component must be processed in accordance with the current revision of IPC/JEDEC standard J-STD-020. Failure to follow the recommended guidelines may cause permanent damage to the device resulting in impaired performance and/or a reduced lifetime expectancy.

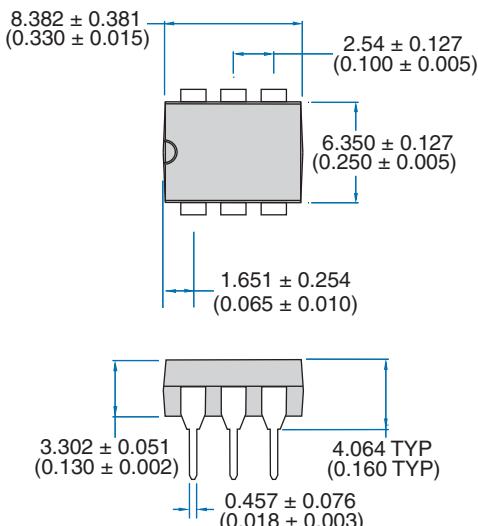
Washing

Clare does not recommend ultrasonic cleaning or the use of chlorinated solvents.

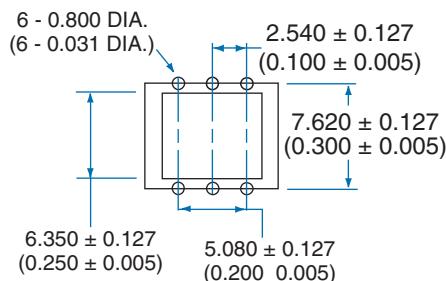


MECHANICAL DIMENSIONS

6-Pin DIP Thru-Hole Package

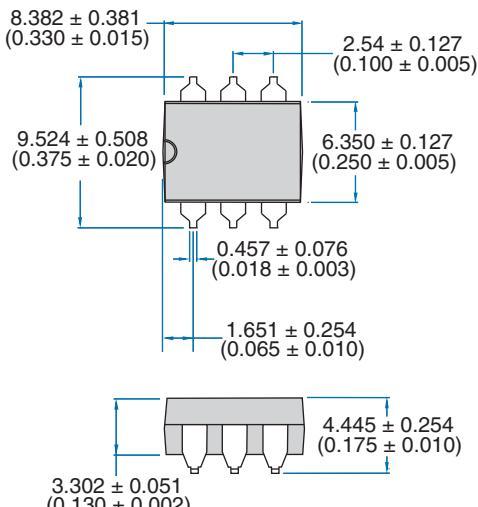


PC Board Pattern

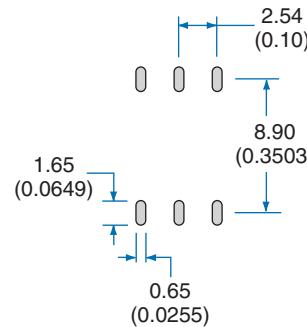


Dimensions
mm
(inches)

6-Pin Surface Mount Package ("S" Suffix)



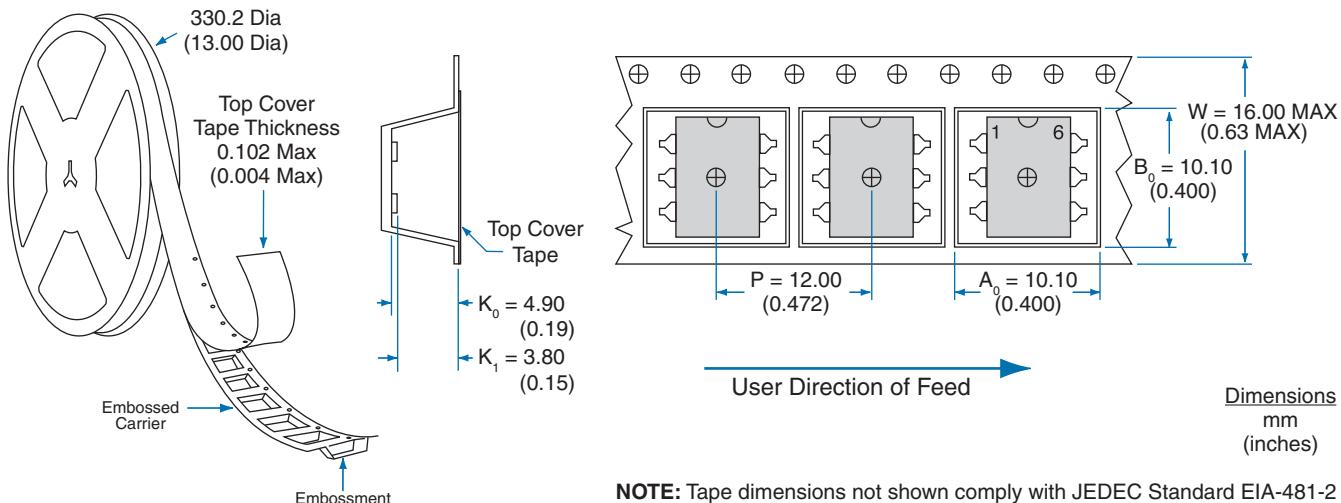
Recommended PCB Land Pattern



Dimensions
mm
(inches)

MECHANICAL DIMENSIONS (Cont.)

Tape and Reel Packaging for 6-Pin "S" Suffix Parts



For additional information please visit our website at: www.clare.com

Clare, Inc. makes no representations or warranties with respect to the accuracy or completeness of the contents of this publication and reserves the right to make changes to specifications and product descriptions at any time without notice. Neither circuit patent licenses nor indemnity are expressed or implied. Except as set forth in Clare's Standard Terms and Conditions of Sale, Clare, Inc. assumes no liability whatsoever, and disclaims any express or implied warranty, relating to its products including, but not limited to, the implied warranty of merchantability, fitness for a particular purpose, or infringement of any intellectual property right.

The products described in this document are not designed, intended, authorized or warranted for use as components in systems intended for surgical implant into the body, or in other applications intended to support or sustain life, or where malfunction of Clare's product may result in direct physical harm, injury, or death to a person or severe property or environmental damage. Clare, Inc. reserves the right to discontinue or make changes to its products at any time without notice.